Tyrone Camarero Specifications

Camerero: SDI100C2TP-14

Key Feature

High Performance Computing, Hyper-Converged Infrastructure, Big Data / Big Sciencet

- Two hot-pluggable systems (nodes) in a 1U form factor. Each node supports the following:
- Dual Socket P+ (LGA-4189) 3rd Generation Intel® Xeon® Scalable Processors
- Intel® C621A Chipset
- 16 DIMMs, Up to 4TB 3DS ECC DDR4-3200 LRDIMM/RDIMM
- 2 PCle 4.0 x16 (LP), 1 PCle 4.0 x8 (with M.2 adapter installed for support 2 NVME up to 22x80 mm)
- Intel® X710 Dual port 10GBase-T LAN onboard
- 4x 2.5" hot-swap SATA drive bays
- 6 counter-rotating 4cm PWM fans with optimal fan speed control (Per System)
- Two 1000W redundant power supplies with PMBus
- SATA (6Gbps); 4 slots per node; RAID 0, 1, 5, 10 support, ASPEED AST2600 BMC, 2 USB, VGA. RoT







Processor/Cache

Processor Dual Socket P+ (LGA-4189) 3rd Generation

Intel® Xeon® Scalable Processors.

Note: Supports up to 185W TDP CPUs (Air

Cooled)

System Memory

Memory 16 DIMMs, Up to 4TB 3DS ECC Capacity DDR4-3200 LRDIMM/RDIMM

Chipset

Chipset Intel® C621A

Expansion Slot

PCI-Express 2 PCIe 4.0 x16 (LP), 1 PCIe 4.0 x8 (with M.2

adapter installed for support 2 NVME up to

22x80 mm)

Integrated Onboard:

SATA 10 SATA (6Gbps) port(s) ,RAID 0/1/5/10

support

Network 2x 10GbE BaseT with Intel® X550

Connectivity

LAN 1 RJ45 Dedicated IPMI LAN port, 2 RJ45

10GBase-T LAN ports

Add-on Options

Raid Card Optional

Optical Drive

None

Front Panel

LED Network activity LED, Power status LED,

System information (overheat/UID) LED

Buttons Power On/Off button, UID button

Drive bays

HDD Bays 4x 2.5" hot-swap SATA drive bays

Power Supply

Power Supply Two 1000W redundant power supplies

with PMBus

Cooling System

Fans 6x 4cm heavy duty fans with optimal

fan speed control

Air Shroud 2 Air Shroud(s)

Form Factor

Form Factor 1U Rackmount

Dimensions

Dimensions Height: 1.7" (43 mm), Width: 17.25" (438

mm), Depth : 28.25" (718 mm)

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www.tyronesystems.com

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